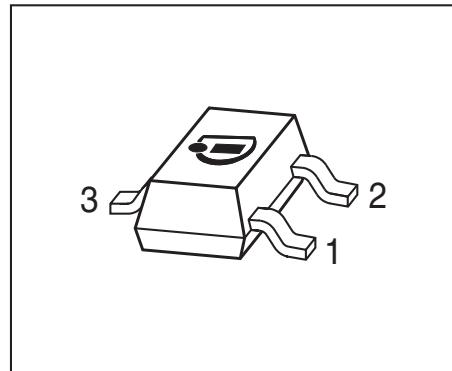


## NPN Silicon Darlington Transistors

- For general AF applications
- High collector current
- High current gain
- Complementary types: BCV26, BCV46 (PNP)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



RoHS

Type	Marking	Pin Configuration			Package
BCV27	FFs	1=B	2=E	3=C	SOT23
BCV47	FGs	1=B	2=E	3=C	SOT23

## Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage BCV27	$V_{CEO}$	30	V
BCV47		60	
Collector-base voltage BCV27	$V_{CBO}$	40	
BCV47		80	
Emitter-base voltage	$V_{EBO}$	10	
Collector current	$I_C$	500	mA
Peak collector current, $t_p \leq 10$ ms	$I_{CM}$	800	
Base current	$I_B$	100	
Peak base current	$I_{BM}$	200	
Total power dissipation- $T_S \leq 74$ °C	$P_{tot}$	360	mW
Junction temperature	$T_j$	150	
Storage temperature	$T_{stg}$	-65 ... 150	°C

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{\text{thJS}}$	$\leq 210$	K/W

<sup>1)</sup>For calculation of  $R_{\text{thJA}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)

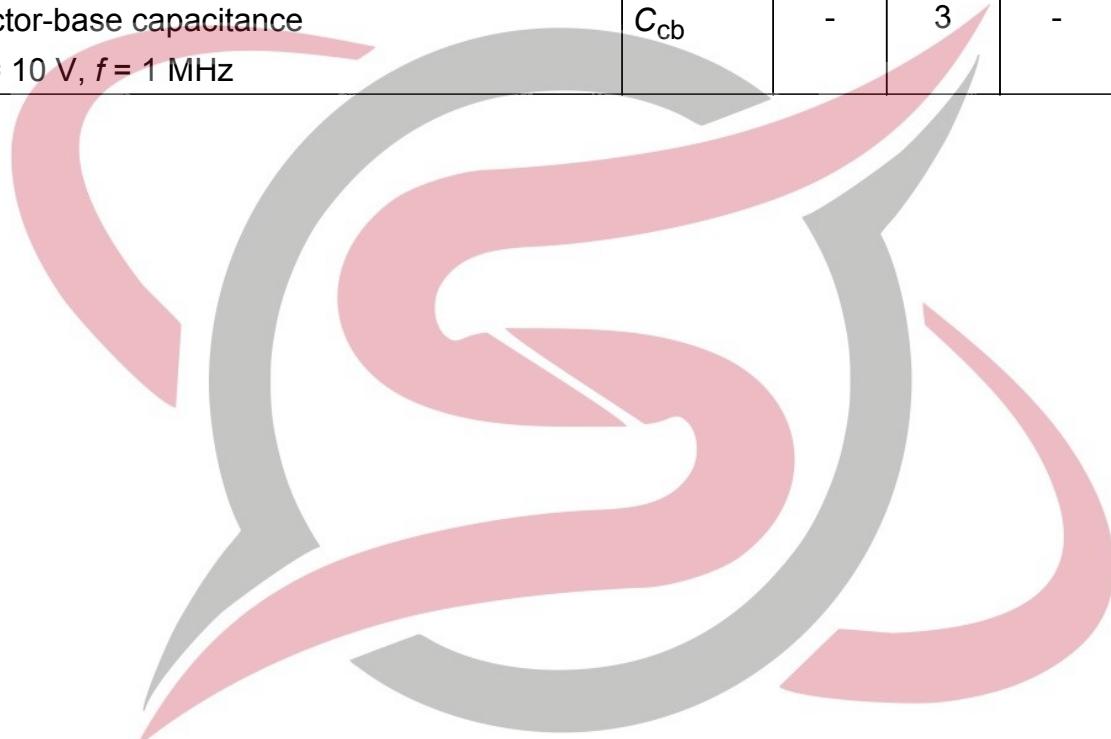
**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Collector-emitter breakdown voltage $I_C = 10 \text{ mA}, I_B = 0$ , BCV27	$V_{(\text{BR})\text{CEO}}$	30	-	-	-
$I_C = 10 \text{ mA}, I_B = 0$ , BCV47		60	-	-	-
Collector-base breakdown voltage $I_C = 100 \mu\text{A}, I_E = 0$ , BCV27	$V_{(\text{BR})\text{CBO}}$	40	-	-	-
$I_C = 100 \mu\text{A}, I_E = 0$ , BCV47		80	-	-	-
Emitter-base breakdown voltage $I_E = 10 \mu\text{A}, I_C = 0$	$V_{(\text{BR})\text{EBO}}$	10	-	-	V
Collector-base cutoff current $V_{CB} = 30 \text{ V}, I_E = 0$ , BCV27	$I_{\text{CBO}}$	-	-	0.1	$\mu\text{A}$
$V_{CB} = 60 \text{ V}, I_E = 0$ , BCV47		-	-	0.1	
$V_{CB} = 30 \text{ V}, I_E = 0, T_A = 150^\circ\text{C}$ , BCV27		-	-	10	
$V_{CB} = 60 \text{ V}, I_E = 0, T_A = 150^\circ\text{C}$ , BCV47		-	-	10	
Emitter-base cutoff current $V_{EB} = 4 \text{ V}, I_C = 0$	$I_{\text{EBO}}$	-	-	100	nA
DC current gain <sup>1)</sup> $I_C = 100 \mu\text{A}, V_{CE} = 1 \text{ V}$ , BCV27	$h_{\text{FE}}$	4000	-	-	-
$I_C = 100 \mu\text{A}, V_{CE} = 1 \text{ V}$ , BCV47		2000	-	-	-
$I_C = 10 \text{ mA}, V_{CE} = 5 \text{ V}$ , BCV27		10000	-	-	-
$I_C = 10 \text{ mA}, V_{CE} = 5 \text{ V}$ , BCV47		4000	-	-	-
$I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}$ , BCV27		20000	-	-	-
$I_C = 100 \text{ mA}, V_{CE} = 5 \text{ V}$ , BCV47		10000	-	-	-
$I_C = 0.5 \text{ A}, V_{CE} = 5 \text{ V}$ , BCV27		4000	-	-	-
$I_C = 0.5 \text{ A}, V_{CE} = 5 \text{ V}$ , BCV47		2000	-	-	-
Collector-emitter saturation voltage <sup>1)</sup> $I_C = 100 \text{ mA}, I_B = 0.1 \text{ mA}$	$V_{\text{CEsat}}$	-	-	1	V
Base emitter saturation voltage <sup>1)</sup> $I_C = 100 \text{ mA}, I_B = 0.1 \text{ mA}$	$V_{\text{BEsat}}$	-	-	1.5	

<sup>1</sup>Pulse test: t < 300µs; D < 2%

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

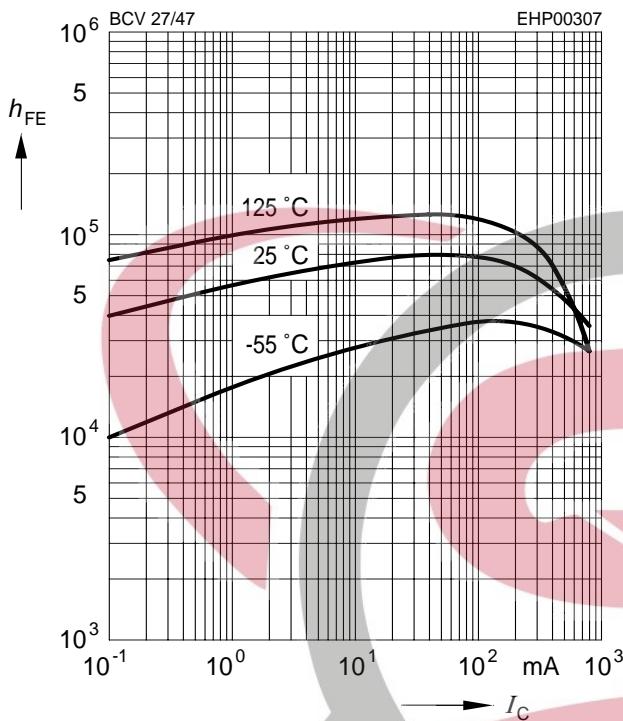
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b>					
Transition frequency $I_C = 50 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$	$f_T$	-	170	-	MHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	$C_{cb}$	-	3	-	pF



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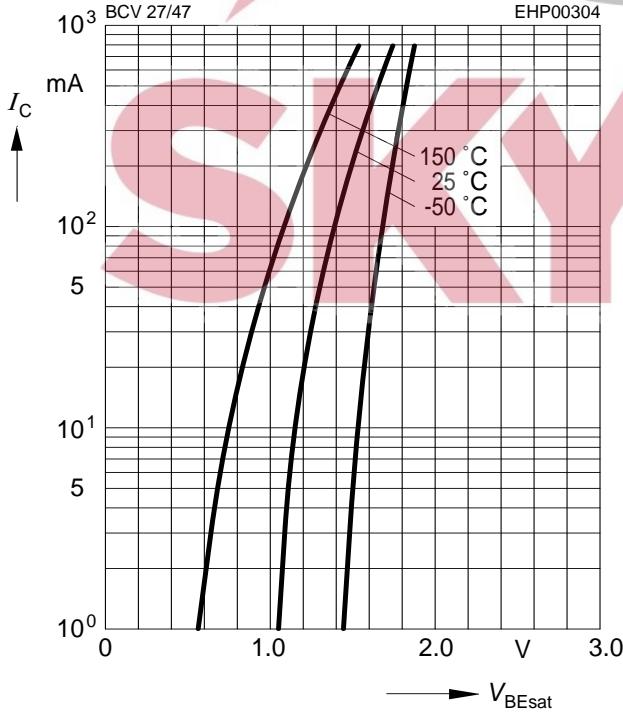
**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 5 \text{ V}$



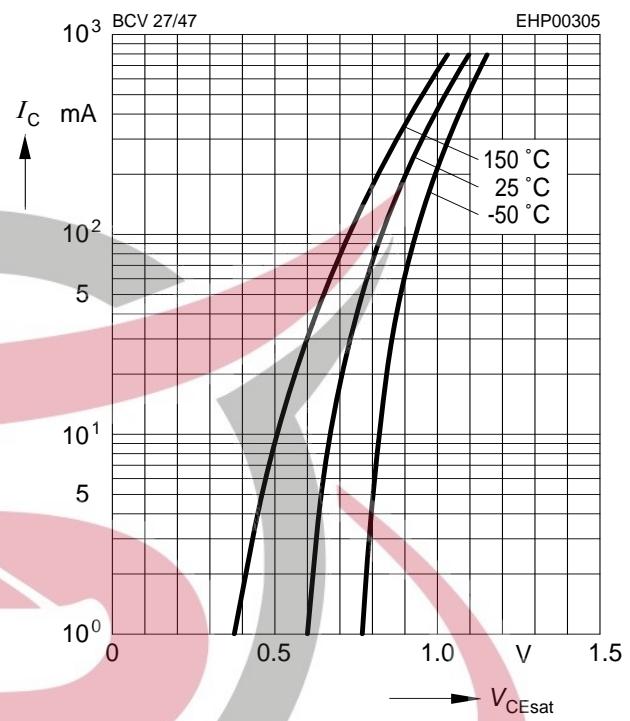
**Base-emitter saturation voltage**

$I_C = f(V_{BEsat}), h_{FE} = 10$



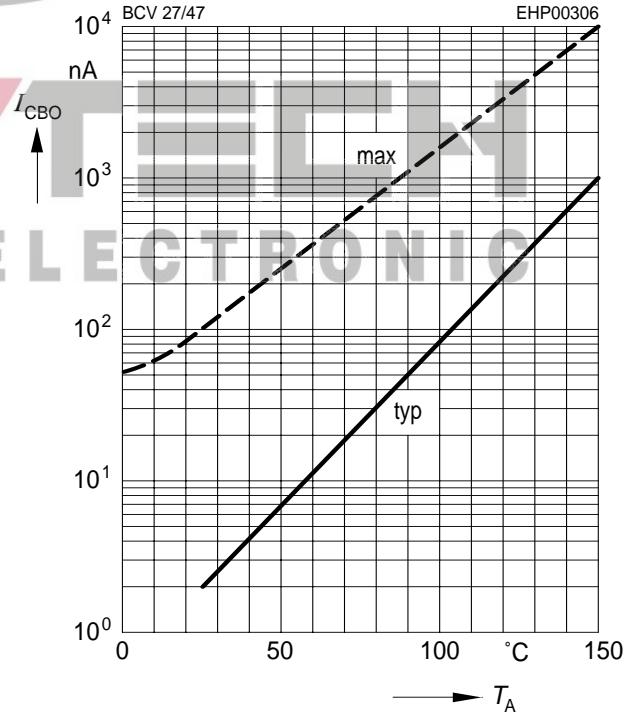
**Collector-emitter saturation voltage**

$I_C = f(V_{CEsat}), h_{FE} = 10$

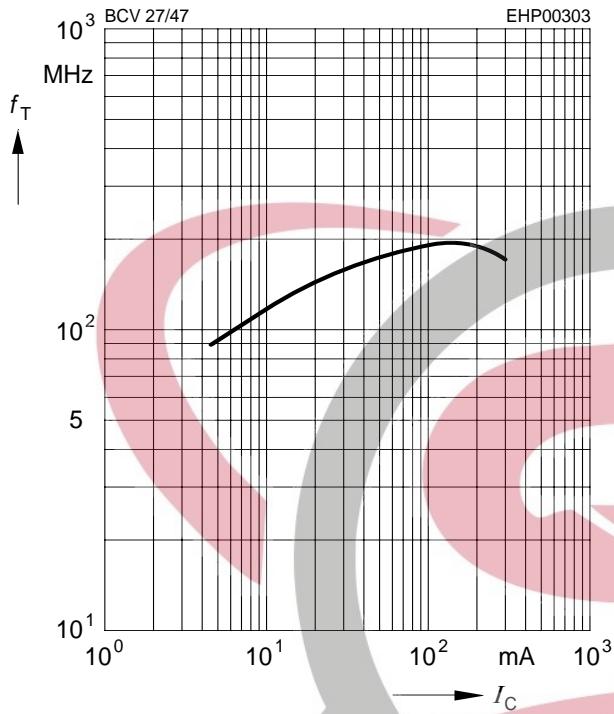


**Collector cutoff current  $I_{CBO} = f(T_A)$**

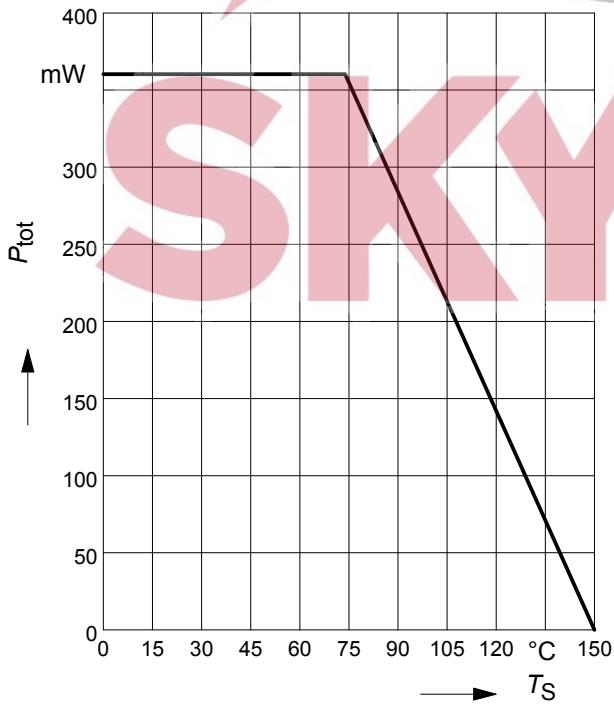
$V_{CB} = V_{CEmax}$



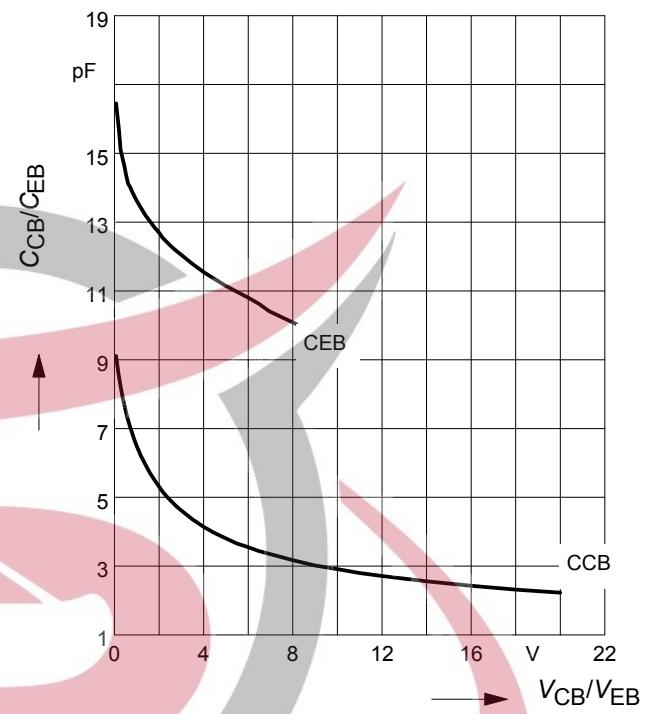
**Transition frequency**  $f_T = f(I_C)$   
 $V_{CE} = 5 \text{ V}$



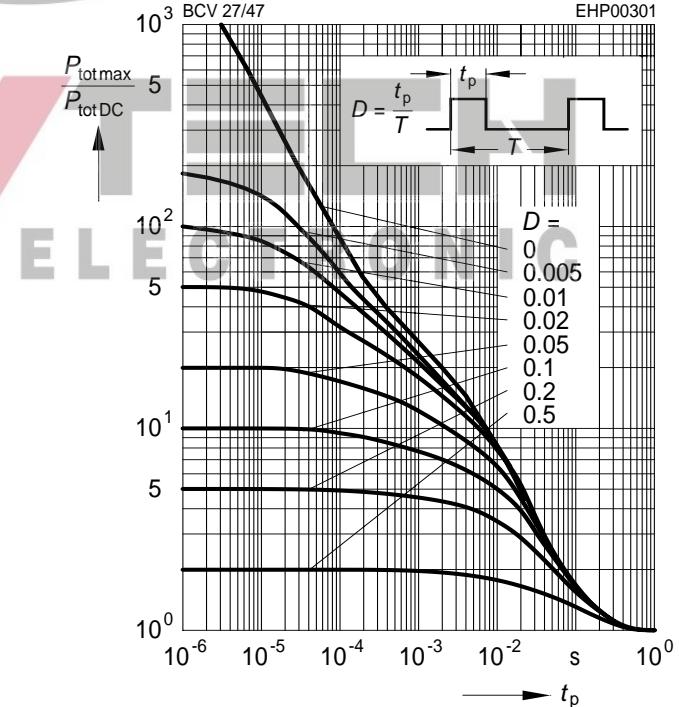
**Total power dissipation**  $P_{tot} = f(T_S)$



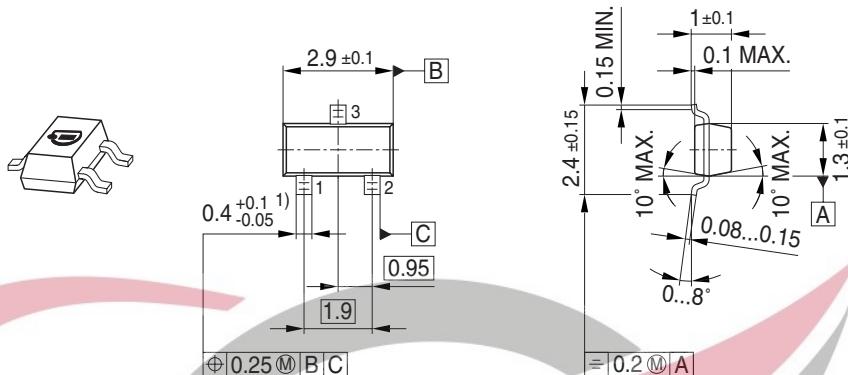
**Collector-base capacitance**  $C_{cb} = f(V_{CB})$   
**Emitter-base capacitance**  $C_{eb} = f(V_{EB})$



**Permissible Pulse Load**  
 $P_{totmax}/P_{totDC} = f(t_p)$

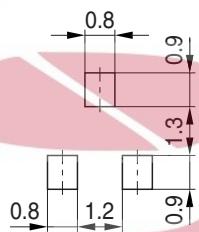


## Package Outline

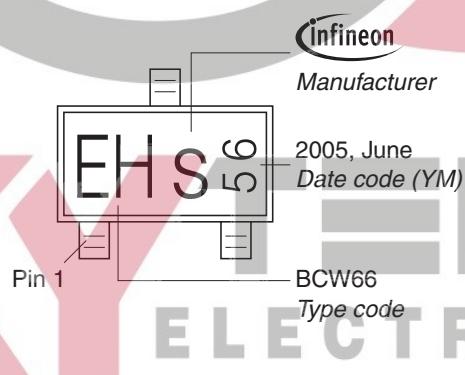


## Foot Print

1) Lead width can be 0.6 max. in dambar area

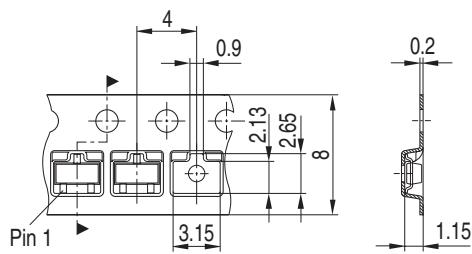


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel



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